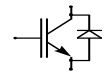


Technische Information / Technical Information

IGBT-Module
IGBT-Modules

BSM 75 GB 60 DLC

eupec



Höchstzulässige Werte / Maximum rated values

Elektrische Eigenschaften / Electrical properties

| | | | | |
|--|--|--------------|---------|----------------------|
| Kollektor-Emitter-Sperrspannung collector-emitter voltage | | V_{CES} | 600 | V |
| Kollektor-Dauergleichstrom DC-collector current | $T_c = 75^\circ\text{C}$ | $I_{C,nom.}$ | 75 | A |
| | $T_c = 25^\circ\text{C}$ | I_C | 100 | A |
| Periodischer Kollektor Spitzenstrom repetitive peak collector current | $t_p = 1\text{ms}, T_c = 75^\circ\text{C}$ | I_{CRM} | 150 | A |
| Gesamt-Verlustleistung total power dissipation | $T_c = 25^\circ\text{C}$, Transistor | P_{tot} | 355 | W |
| Gate-Emitter-Spitzenspannung gate-emitter peak voltage | | V_{GES} | +/- 20V | V |
| Dauergleichstrom DC forward current | | I_F | 75 | A |
| Periodischer Spitzenstrom repetitive peak forw. current | $t_p = 1\text{ms}$ | I_{FRM} | 150 | A |
| Grenzlastintegral der Diode I^2t - value, Diode | $V_R = 0\text{V}, t_p = 10\text{ms}, T_{vj} = 125^\circ\text{C}$ | I^2t | 450 | A^2s |
| Isolations-Prüfspannung insulation test voltage | RMS, $f = 50\text{Hz}, t = 1\text{min.}$ | V_{ISOL} | 2,5 | kV |

Charakteristische Werte / Characteristic values

Transistor / Transistor

| | | | min. | typ. | max. | |
|--|---|---------------------|------|------|------|---------------|
| Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage | $I_C = 75\text{A}, V_{GE} = 15\text{V}, T_{vj} = 25^\circ\text{C}$ | $V_{CE\text{ sat}}$ | - | 1,95 | 2,45 | V |
| | $I_C = 75\text{A}, V_{GE} = 15\text{V}, T_{vj} = 125^\circ\text{C}$ | | - | 2,20 | - | V |
| Gate-Schwellenspannung gate threshold voltage | $I_C = 1,5\text{mA}, V_{CE} = V_{GE}, T_{vj} = 25^\circ\text{C}$ | $V_{GE(th)}$ | 4,5 | 5,5 | 6,5 | V |
| Eingangskapazität input capacitance | $f = 1\text{MHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$ | C_{ies} | - | 3,3 | - | nF |
| Rückwirkungskapazität reverse transfer capacitance | $f = 1\text{MHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$ | C_{res} | - | 0,3 | - | nF |
| Kollektor-Emitter Reststrom collector-emitter cut-off current | $V_{CE} = 600\text{V}, V_{GE} = 0\text{V}, T_{vj} = 25^\circ\text{C}$ | I_{CES} | - | 1 | 500 | μA |
| | $V_{CE} = 600\text{V}, V_{GE} = 0\text{V}, T_{vj} = 125^\circ\text{C}$ | | - | 1 | - | mA |
| Gate-Emitter Reststrom gate-emitter leakage current | $V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_{vj} = 25^\circ\text{C}$ | I_{GES} | - | - | 400 | nA |

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revision: 1



Charakteristische Werte / Characteristic values

Transistor / Transistor

| | | | min. | typ. | max. | |
|--|--|-----------------|------|------|------|----|
| Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load) | $I_C=75A, V_{CC}=300V$ | $t_{d,on}$ | - | 63 | - | ns |
| | $V_{GE}=\pm 15V, R_G=3,0\Omega, T_{vj}=25^\circ C$ | | | | | |
| | $V_{GE}=\pm 15V, R_G=3,0\Omega, T_{vj}=125^\circ C$ | | | | | |
| Anstiegszeit (induktive Last) rise time (inductive load) | $I_C=75A, V_{CC}=300V$ | t_r | - | 22 | - | ns |
| | $V_{GE}=\pm 15V, R_G=3,0\Omega, T_{vj}=25^\circ C$ | | | | | |
| | $V_{GE}=\pm 15V, R_G=3,0\Omega, T_{vj}=125^\circ C$ | | | | | |
| Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load) | $I_C=75A, V_{CC}=300V$ | $t_{d,off}$ | - | 155 | - | ns |
| | $V_{GE}=\pm 15V, R_G=3,0\Omega, T_{vj}=25^\circ C$ | | | | | |
| | $V_{GE}=\pm 15V, R_G=3,0\Omega, T_{vj}=125^\circ C$ | | | | | |
| Fallzeit (induktive Last) fall time (inductive load) | $I_C=75A, V_{CC}=300V$ | t_f | - | 20 | - | ns |
| | $V_{GE}=\pm 15V, R_G=3,0\Omega, T_{vj}=25^\circ C$ | | | | | |
| | $V_{GE}=\pm 15V, R_G=3,0\Omega, T_{vj}=125^\circ C$ | | | | | |
| Einschaltverlustenergie pro Puls turn-on energy loss per pulse | $I_C=75A, V_{CC}=300V, V_{GE}=15V$ $R_G=3,0\Omega, T_{vj}=125^\circ C, L_\sigma=30nH$ | E_{on} | - | 0,7 | - | mJ |
| Abschaltverlustenergie pro Puls turn-off energy loss per pulse | $I_C=75A, V_{CC}=300V, V_{GE}=15V$ $R_G=3,0\Omega, T_{vj}=125^\circ C, L_\sigma=30nH$ | E_{off} | - | 2,4 | - | mJ |
| Kurzschlußverhalten SC Data | $t_p \leq 10\mu sec, V_{GE} \leq 15V$ $T_{vj} \leq 125^\circ C, V_{CC}=360V, V_{CEmax} = V_{CES} - L_{\sigma CE} \cdot di/dt$ | I_{SC} | - | 340 | - | A |
| Modulinduktivität stray inductance module | | $L_{\sigma CE}$ | - | 40 | - | nH |
| Modul-Leitungswiderstand, Anschlüsse - Chip lead resistance, terminals - chip | $T_c=25^\circ C$ | R_{CC+EE} | - | 1,2 | - | mΩ |

Charakteristische Werte / Characteristic values

Diode / Diode

| | | | min. | typ. | max. | |
|---|---|-----------|------|------|------|----|
| Durchlaßspannung forward voltage | $I_F=75A, V_{GE}=0V, T_{vj}=25^\circ C$ | V_F | - | 1,25 | 1,6 | V |
| | $I_F=75A, V_{GE}=0V, T_{vj}=125^\circ C$ | | | | | |
| Rückstromspitze peak reverse recovery current | $I_F=75A, -di_F/dt=3000A/\mu sec$ | I_{RM} | - | 95 | - | A |
| | $V_R=300V, V_{GE}=-10V, T_{vj}=25^\circ C$ | | | | | |
| | $V_R=300V, V_{GE}=-10V, T_{vj}=125^\circ C$ | | | | | |
| Sperrverzögerungsladung recovered charge | $I_F=75A, -di_F/dt=3000A/\mu sec$ | Q_r | - | 5,1 | - | μC |
| | $V_R=300V, V_{GE}=-10V, T_{vj}=25^\circ C$ | | | | | |
| | $V_R=300V, V_{GE}=-10V, T_{vj}=125^\circ C$ | | | | | |
| Abschaltenergie pro Puls reverse recovery energy | $I_F=75A, -di_F/dt=3000A/\mu sec$ | E_{rec} | - | - | - | mJ |
| | $V_R=300V, V_{GE}=-10V, T_{vj}=25^\circ C$ $V_R=300V, V_{GE}=-10V, T_{vj}=125^\circ C$ | | | | | |



Thermische Eigenschaften / Thermal properties

| | | | min. | typ. | max. | |
|--|--|------------|------|------|------|-----|
| Innerer Wärmewiderstand thermal resistance, junction to case | Transistor / transistor, DC | R_{thJC} | - | - | 0,35 | K/W |
| | Diode / diode, DC | | - | - | 0,66 | K/W |
| Übergangs-Wärmewiderstand thermal resistance, case to heatsink | pro Modul / per module $\lambda_{Paste} = 1W/m^2K$ / $\lambda_{grease} = 1W/m^2K$ | R_{thCK} | - | 0,03 | - | K/W |
| Höchstzulässige Sperrschichttemperatur maximum junction temperature | | T_{vj} | - | - | 150 | °C |
| Betriebstemperatur operation temperature | | T_{op} | -40 | - | 125 | °C |
| Lagertemperatur storage temperature | | T_{stg} | -40 | - | 125 | °C |

Mechanische Eigenschaften / Mechanical properties

| | | | | | |
|---|-------------------------|----|-----|-----------|---------|
| Gehäuse, siehe Anlage case, see appendix | | | | | |
| Innere Isolation internal insulation | | | | Al_2O_3 | |
| Kriechstrecke creepage insulation | | | | 15 | mm |
| Luftstrecke clearance | | | | 8,5 | mm |
| CTI comperative tracking index | | | | 275 | |
| Anzugsdrehmoment für mech. Befestigung mounting torque | Schraube M6 screw M6 | M1 | -15 | 5 +15 | Nm % |
| Gewicht weight | | G | | 180 | g |

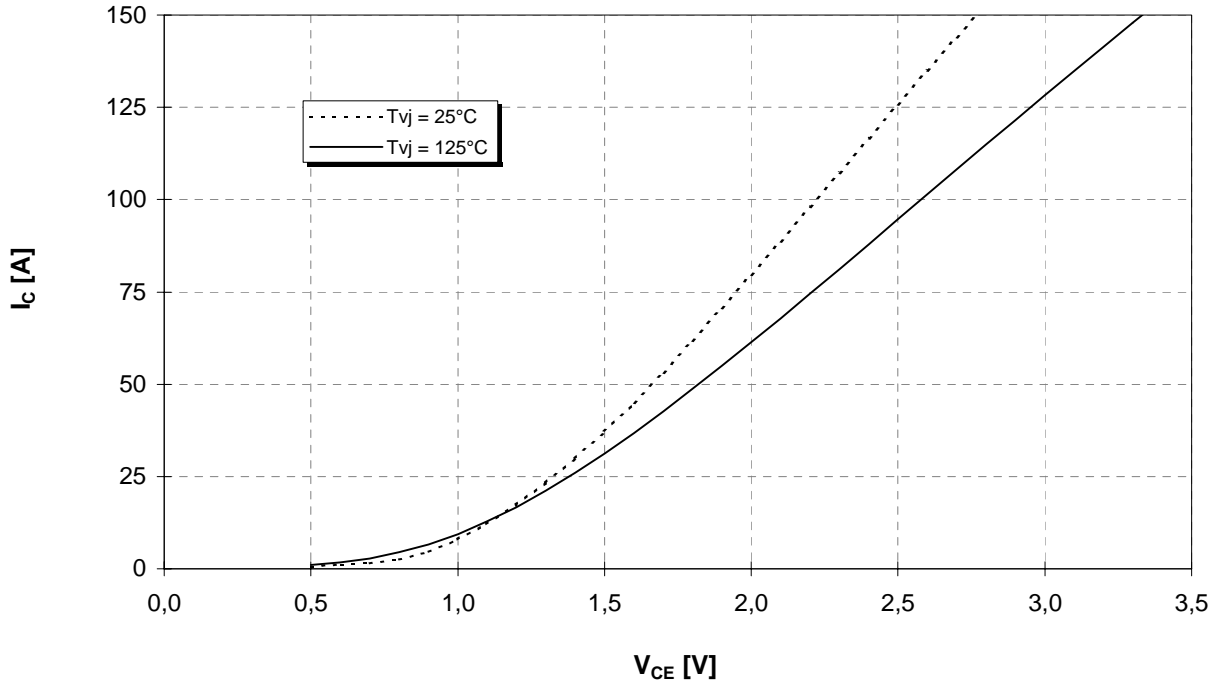
Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen Technischen Erläuterungen.

This technical information specifies semiconductor devices but promises no characteristics. It is valid in combination with the belonging technical notes.



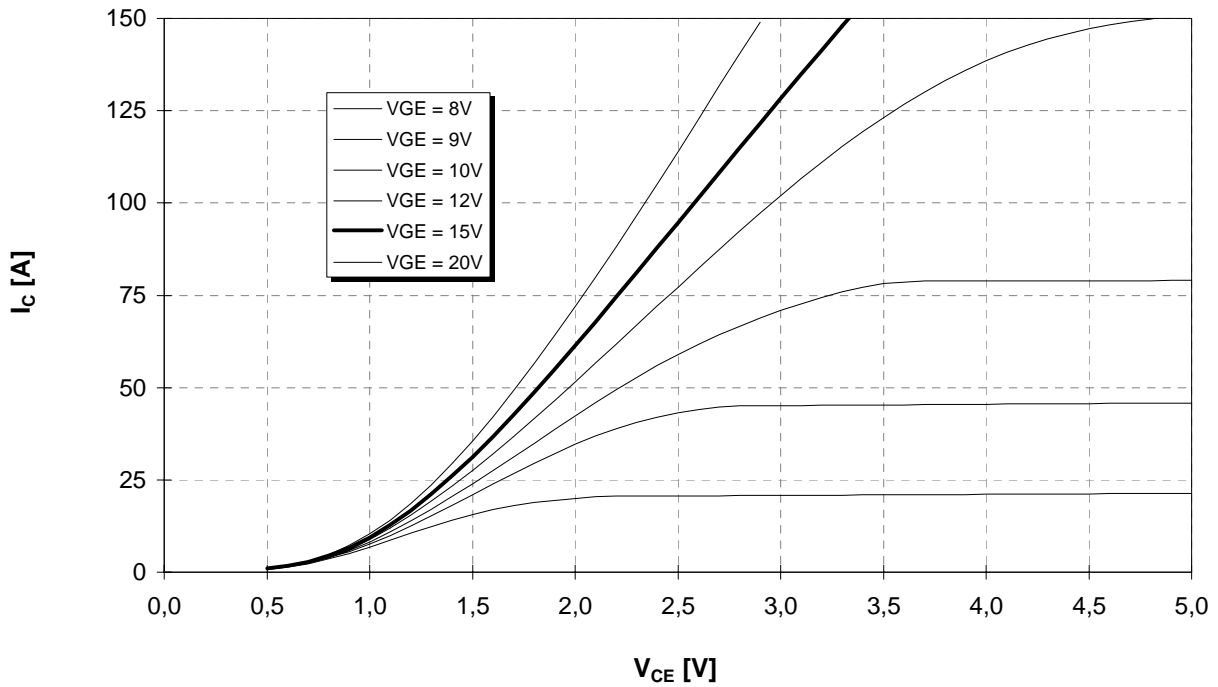
Ausgangskennlinie (typisch)
Output characteristic (typical)

$I_C = f(V_{CE})$
 $V_{GE} = 15V$



Ausgangskennlinienfeld (typisch)
Output characteristic (typical)

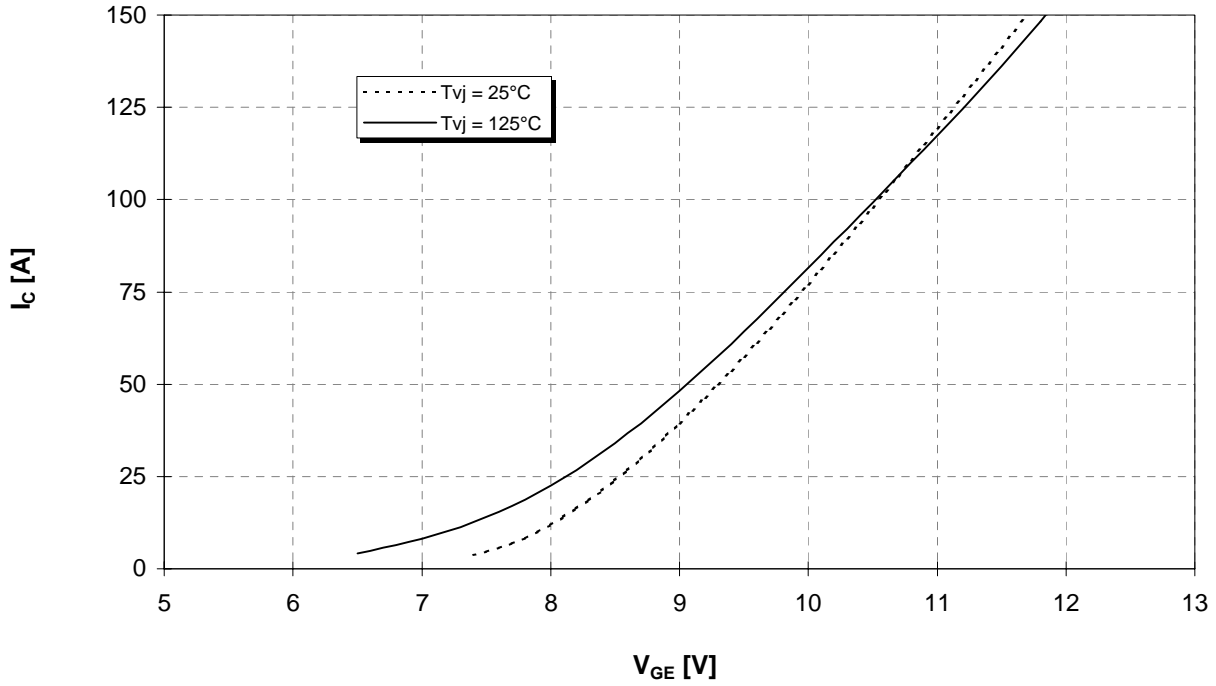
$I_C = f(V_{CE})$
 $T_{vj} = 125^\circ C$





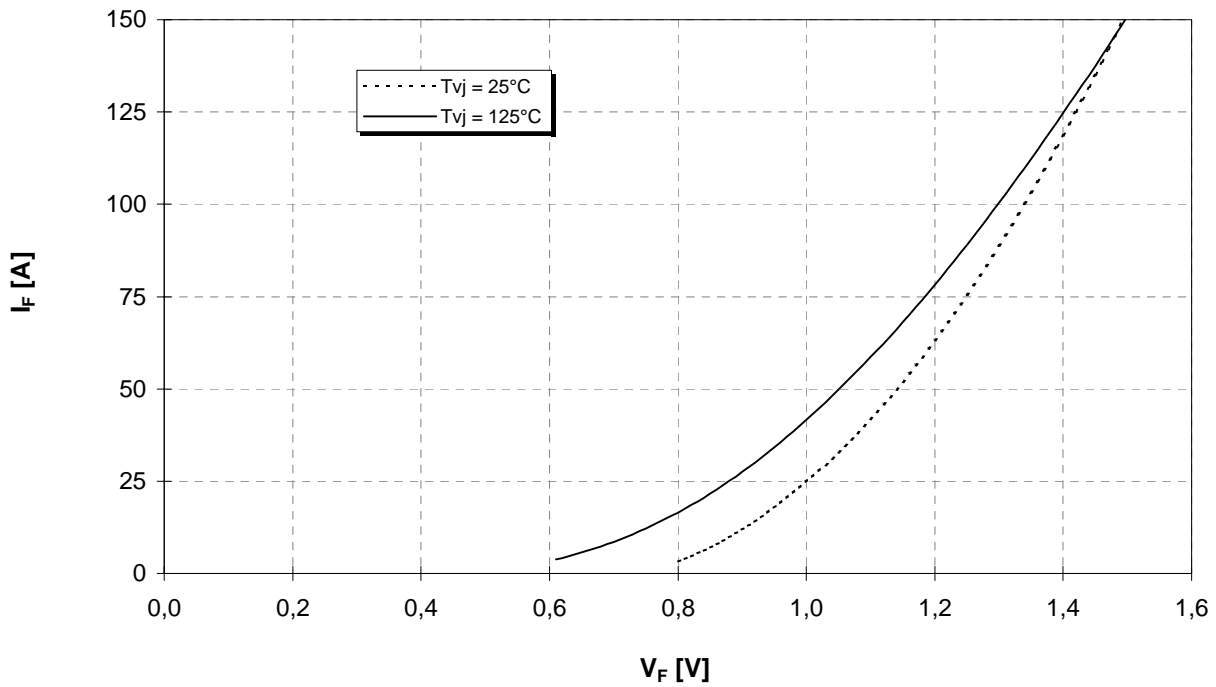
Übertragungscharakteristik (typisch)
Transfer characteristic (typical)

$I_C = f(V_{GE})$
 $V_{CE} = 20V$



Durchlaßkennlinie der Inversdiode (typisch)
Forward characteristic of inverse diode (typical)

$I_F = f(V_F)$

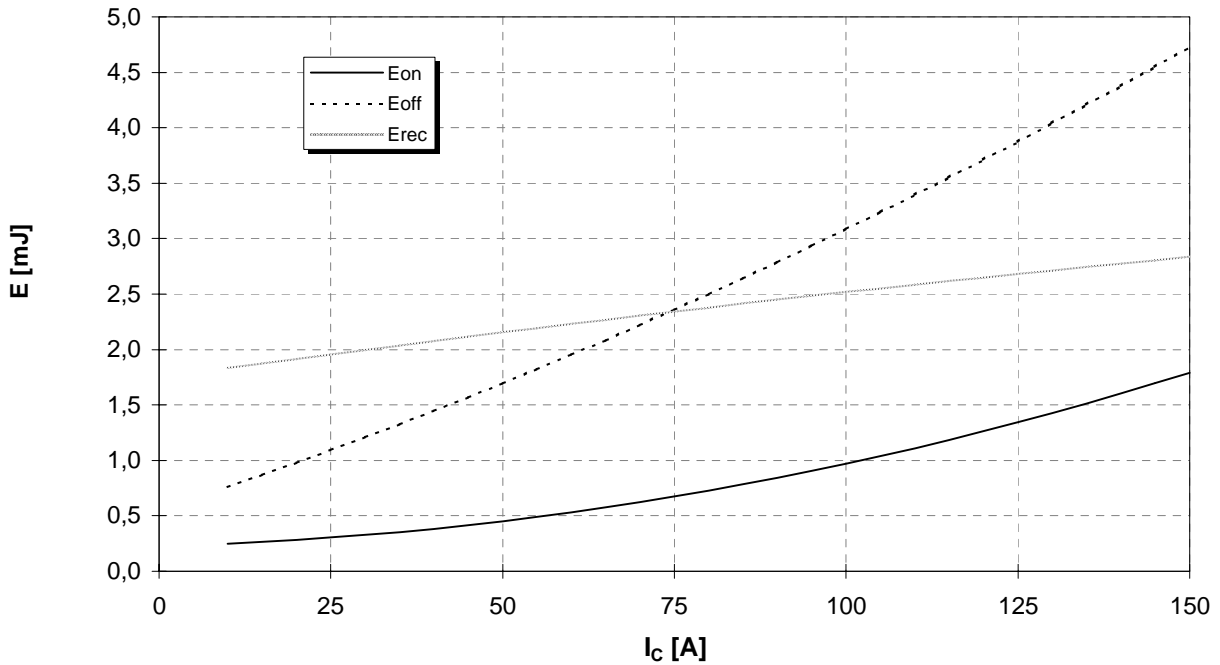




Schaltverluste (typisch)
Switching losses (typical)

$E_{on} = f(I_C), E_{off} = f(I_C), E_{rec} = f(I_C)$

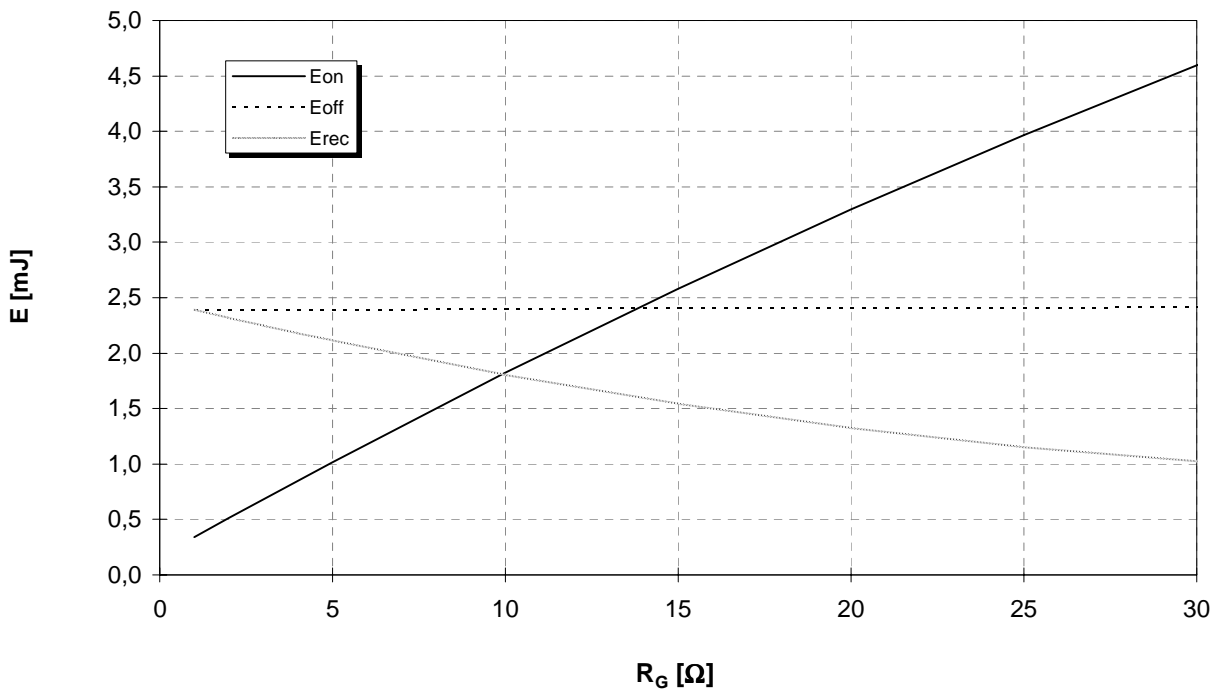
$R_{G,on} = 3,0\Omega, R_{G,off} = 3,0\Omega, V_{CC} = 300V, T_{vj} = 125^\circ C$

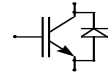


Schaltverluste (typisch)
Switching losses (typical)

$E_{on} = f(R_G), E_{off} = f(R_G), E_{rec} = f(R_G)$

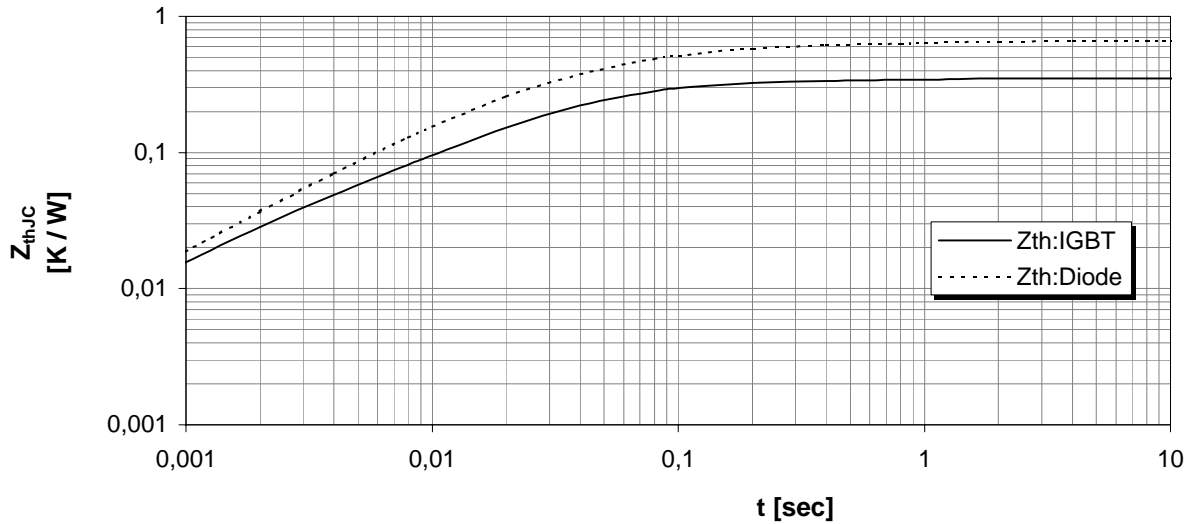
$I_C = 75A, V_{CC} = 300V, T_{vj} = 125^\circ C$





Transienter Wärmewiderstand
Transient thermal impedance

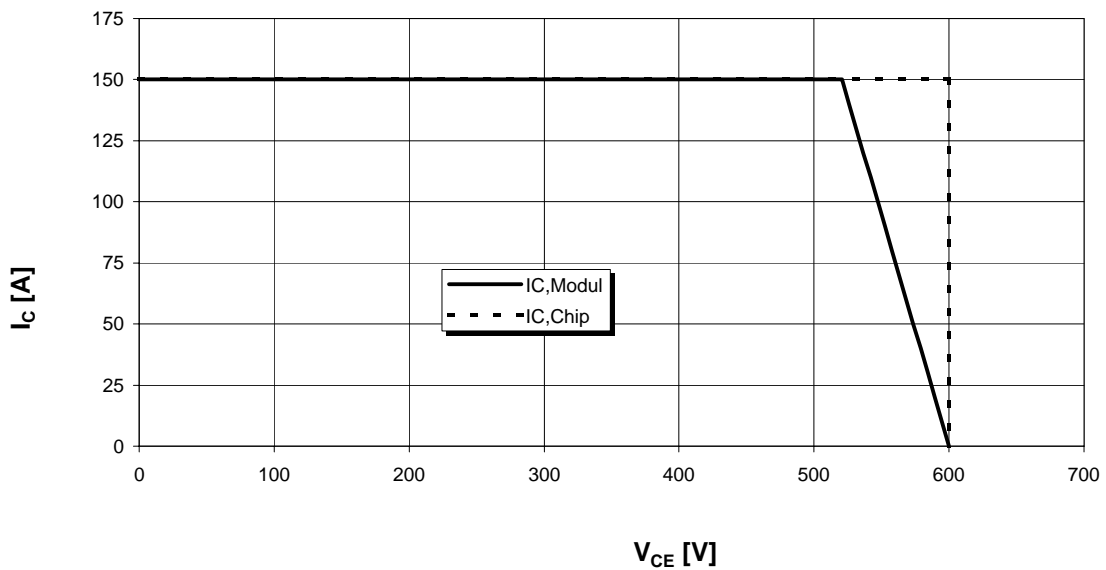
$Z_{thJC} = f(t)$

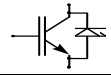


| i | 1 | 2 | 3 | 4 |
|------------------------|--------|--------|--------|--------|
| r_i [K/kW] : IGBT | 14,8 | 183,4 | 123,4 | 28,4 |
| τ_i [sec] : IGBT | 0,0018 | 0,0240 | 0,0651 | 0,6626 |
| r_i [K/kW] : Diode | 232,6 | 223,1 | 140,1 | 64,2 |
| τ_i [sec] : Diode | 0,0487 | 0,0169 | 0,1069 | 0,9115 |

Sicherer Arbeitsbereich (RBSOA)
Reverse bias safe operation area (RBSOA)

$V_{GE} = +15V, R_{G,off} = 3,0\Omega, T_V = 125^\circ C$





Gehäusemaße / Schaltbild
Package outline / Circuit diagram

